Adhesives and Bonding Tools

To obtain good measurement results, the strain gage must be bonded firmly to the measuring object. Thus, it is important to select an adhesive suitable for the materials of both the object being measured and the gage base, as well as for the measuring conditions.

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STRAIN GAGES						EP-340		
IKAII	Models	CC-33A	CC-35	CC-36	EP-270	EP-340	EP-34B	EP-37(
Λ Λ	Types	Instantaneous adhesive cured at normal temperature	Instantaneous adhesive cured at normal temperature	Instantaneous adhesive cured at normal temperature	Cured at normal temperature	Cured at normal temperature or by heating	Cured at normal temperature or by heating	Cured by normal tempera + heating
	Operating Temperature (°C)	-196 to 120 (Regular temperature: 20 to 80)	-30 to 120 (Regular temperature: 20 to 80)	-30 to 100 (Regular temperature: 20 to 80)	-269 to 30	-55 to 150	-55 to 200	Normal temp. to 50
n Gages utline	Major Applicable Materials	 Metals (Steel, stainless steel, copper, aluminum alloys A1050, A2024, etc.) Plastics (Acrylate, PVC, nylon, etc.) Composite materials (CFRP, GFRP, PCB, etc.) Rubber 	●Concrete ●Mortar ●Wood	 Metals (Steel, stainless steel, copper, aluminum alloys A1050, A2024, A7075, magnesium alloy, etc.) Plastics (Acrylate, PVC, nylon, polypropylene, etc.) Composite materials (CFRP, GFRP, PCB, etc.) Concrete Mortar Wood Rubber 	•Metals (Steel, stainless steel, aluminum alloy, etc.)	•Metals (Steel, stainless steel, aluminum alloy, etc.)	 Metals (Steel, stainless steel, copper, aluminum alloy, etc.) Plastics (Acrylate, PVC, etc.) Composite materials (CFRP, GFRP, PCB, etc.) 	 Metals (Steel, stail steel, copper, alur alloy, etc.) Plastics (Acrylate, blastics)
vire cable eneral erproof ncrete site material PCB	Curing Requirements	•Apply finger pressure (100 to 300 kPa) for 15 to 60 seconds. (Then, leave the gage for 1 hour.) *The finger pressure application time differs depending on temperature and humidity conditions. The lower the temperature and humidity, the longer the finger pressure application time required.	•Apply finger pressure (100 to 300 kPa) for 30 to 180 seconds. (After curing, leave the gage for 1 hour or more.) *The finger pressure application time differs depending on temperature and humidity conditions. The lower the temperature and humidity, the longer the finger pressure application time required.	•Apply finger pressure (100 to 300 kPa) for 30 to 60 seconds. (After curing, leave the gage for 1 hour or more.) *The finger pressure application time differs depending on temperature and humidity conditions. The lower the temperature and humidity, the longer the finger pressure application time required.	•Apply pressure (50 ±20 kPa) for 24 hours at approx. 25°C.	 Apply pressure (100 ±50 kPa) for 24 hours at approx. 25°C or for 2 hours at 80°C. Pressing is possible with tape. 	 Apply pressure (30 to 50 kPa) for 24 hours at approx. 25°C or for 2 hours at 80°C. Pressing is possible with tape. 	•Keep at normal temperature for 2 and heat it for 5 80 ℃.
mall strain	Category	1 type of cyanoacrylate liquid	1 type of cyanoacrylate liquid	1 type of cyanoacrylate liquid	2 types of epoxy liquid mixed	2 types of epoxy liquid mixed	2 types of epoxy liquid mixed	2 types of epoxy liquid m
temp. ongation	Capacity	2 g × 1 or 2 g × 5	2 g × 1 or 2 g × 5	2 g × 1 or 2 g × 5	50 g (Main agent: 25 g (Curing agent: 25 g	30 g (Main agent: 6 g x 4 (Curing agent: 1.5 g x 4	30.8 g (Main agent: 5.6 g x 4 Curing agent: 2.1 g x 4	40 g (Main agent: Curing agent:
Non- etoresistive ogen gas ending protector bedded Crack	Features	 Suitable for bonding general-purpose gages which are used for general stress measurement at normal temperature. Quick curing ensures smooth bonding workability. Enables measurement in approximately 1 hour from bonding. 	 High viscosity makes it suitable for bonding to porous materials such lumber and concrete. Suitable for bonding general-purpose gages which are used for general stress measurement at normal temperature. 	 Suitable for bonding a high-elongation gage (such as KFEM and KFEL) at normal temperature. Suitable for bonding to non-adhesive materials such as aluminum alloy (A7075) and magnesium alloy. High peeling resistance, high impact resistance and less aging deterioration of bonding strength 	•Suitable for bonding gages for strain measurement at very low temperature.	•Suitable for bonding gages for strain measurement at mid temperature.	•Suitable for bonding gages for strain measurement at mid temperature and for bonding gages for transducers.	•Low viscosity mak suitable for bond gages (KFB) in bo
Ihesive ng agent Istom- signed	Major Applicable Gages	KFGS, KFGT, KFRB, KFWB, KFWS, KFRPB, KFRS, KFP, KSPB, KSN (Excl. E5) KSPH, KSPLB, KFLB, KFNB, KFSB, KFF, KCH, KV	KFGS, KFGT, KFRB, KC, KFRPB, KFP	KFEM, KFEL, KFGS, KFGT, KFRB, KFWB, KFWS, KFRPB, KFRS, KFP, KSPB, KSN (Excl. E5), KSPH, KSPLB, KFF, KV	KFLB	KFGS, KFRB, KFWB, KFGT, KFF, KFSB	KFRPB, KFP, KFHB	KFB

-47

Note: The stated operating temperature range is for the adhesive only, and may differ depending on combinations with gages. When using the adhesives and gages together, read the attached instruction manual carefully.

1-47

TRACE CONTRACTOR		strain page coment PI-32
P-370	PC-600	PI-32
by I temperature ng	Cured by heating	Cured by heating
Normal mp. to 50	-269 to 250	-269 to 350
teel, stainless per, aluminum) Acrylate, PVC, etc.)	•Metals (Steel, stainless steel, copper, aluminum alloy, etc.)	•Metals (Steel, stainless steel, copper, aluminum alloy, etc.)
hormal ture for 24 hours t it for 5 hours at	•Apply pressure (150 to 300 kPa) for 1 hour at 80°C →2 hours at 130°C →2 hours at 150°C.	 Apply pressure (200 to 500 kPa) for 1 hour at 100°C →2 hours at 200°C →2 hours at the operating temperature with the pressure removed. *If it is difficult to heat at 200°C, 2 h at 200°C may be changed to 5 h at 160°C with all other conditions followed.
types of liquid mixed	1 heating type of phenol liquid	1 heating type of polyimide liquid
agent: 30 g g agent: 10 g	100 g	20 g
osity makes it for bonding FB) in bolts.	•Suitable for bonding gages for strain measurement at low, mid and high temperatures and for bonding gages for transducers.	•Suitable for bonding gages for strain measurement at high temperature.
	KFGS, KFRB, KFHB, KFLB, KFNB	KFU, KFHB

-48

STRAIN GAGES



Outline

Lead-wire cable

General

Waterproof

Concrete

Composite material PCB Plastics

Ultra-small strain High temp. Low temp.

High elongation

Nonmagnetoresistive

Hydrogen gas Bending

With protector Embedded

Crack

Adhesive Coating agent

> Customdesigned